

TQG144: 144-lead Thin Quad Flat Package

The XC3S50AN is available in the 144-lead thin quad flat package, TQG144.

Table 66 lists all the package pins. They are sorted by bank number and then by pin name. Pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier.

The XC3S50AN does not support the address output pins for the Byte-wide Peripheral Interface (BPI) configuration mode.

An electronic version of this package pinout table and footprint diagram is available for download from the Xilinx website at

www.xilinx.com/support/documentation/data_sheets/s3a_pin.zip.

Pinout Table

Table 66: Spartan-3AN TQG144 Pinout

Bank	Pin Name	Pin	Type
0	IO_0	P142	I/O
0	IO_L01N_0	P111	I/O
0	IO_L01P_0	P110	I/O
0	IO_L02N_0	P113	I/O
0	IO_L02P_0/VREF_0	P112	VREF
0	IO_L03N_0	P117	I/O
0	IO_L03P_0	P115	I/O
0	IO_L04N_0	P116	I/O
0	IO_L04P_0	P114	I/O
0	IO_L05N_0	P121	I/O
0	IO_L05P_0	P120	I/O
0	IO_L06N_0/GCLK5	P126	GCLK
0	IO_L06P_0/GCLK4	P124	GCLK
0	IO_L07N_0/GCLK7	P127	GCLK
0	IO_L07P_0/GCLK6	P125	GCLK
0	IO_L08N_0/GCLK9	P131	GCLK
0	IO_L08P_0/GCLK8	P129	GCLK
0	IO_L09N_0/GCLK11	P132	GCLK
0	IO_L09P_0/GCLK10	P130	GCLK
0	IO_L10N_0	P135	I/O
0	IO_L10P_0	P134	I/O
0	IO_L11N_0	P139	I/O
0	IO_L11P_0	P138	I/O
0	IO_L12N_0/PUDC_B	P143	DUAL
0	IO_L12P_0/VREF_0	P141	VREF
0	IP_0	P140	INPUT

Table 66: Spartan-3AN TQG144 Pinout (Continued)

Bank	Pin Name	Pin	Type
0	IP_0/VREF_0	P123	VREF
0	VCCO_0	P119	VCCO
0	VCCO_0	P136	VCCO
1	IO_1	P79	I/O
1	IO_L01N_1/LDC2	P78	DUAL
1	IO_L01P_1/HDC	P76	DUAL
1	IO_L02N_1/LDC0	P77	DUAL
1	IO_L02P_1/LDC1	P75	DUAL
1	IO_L03N_1	P84	I/O
1	IO_L03P_1	P82	I/O
1	IO_L04N_1/RHCLK1	P85	RHCLK
1	IO_L04P_1/RHCLK0	P83	RHCLK
1	IO_L05N_1/TRDY1/RHCLK3	P88	RHCLK
1	IO_L05P_1/RHCLK2	P87	RHCLK
1	IO_L06N_1/RHCLK5	P92	RHCLK
1	IO_L06P_1/RHCLK4	P90	RHCLK
1	IO_L07N_1/RHCLK7	P93	RHCLK
1	IO_L07P_1/IRDY1/RHCLK6	P91	RHCLK
1	IO_L08N_1	P98	I/O
1	IO_L08P_1	P96	I/O
1	IO_L09N_1	P101	I/O
1	IO_L09P_1	P99	I/O
1	IO_L10N_1	P104	I/O
1	IO_L10P_1	P102	I/O
1	IO_L11N_1	P105	I/O
1	IO_L11P_1	P103	I/O
1	IP_1/VREF_1	P80	VREF
1	IP_1/VREF_1	P97	VREF
1	SUSPEND	P74	PWR MGMT
1	VCCO_1	P86	VCCO
1	VCCO_1	P95	VCCO
2	IO_2/MOSI/CSI_B	P62	DUAL
2	IO_L01N_2/M0	P38	DUAL
2	IO_L01P_2/M1	P37	DUAL
2	IO_L02N_2/CSO_B	P41	DUAL
2	IO_L02P_2/M2	P39	DUAL
2	IO_L03N_2/VS1	P44	DUAL
2	IO_L03P_2/RDWR_B	P42	DUAL
2	IO_L04N_2/VS0	P45	DUAL
2	IO_L04P_2/VS2	P43	DUAL

Table 66: Spartan-3AN TQG144 Pinout (Continued)

Bank	Pin Name	Pin	Type
2	IO_L05N_2/D7	P48	DUAL
2	IO_L05P_2	P46	I/O
2	IO_L06N_2/D6	P49	DUAL
2	IO_L06P_2	P47	I/O
2	IO_L07N_2/D4	P51	DUAL
2	IO_L07P_2/D5	P50	DUAL
2	IO_L08N_2/GCLK15	P55	GCLK
2	IO_L08P_2/GCLK14	P54	GCLK
2	IO_L09N_2/GCLK1	P59	GCLK
2	IO_L09P_2/GCLK0	P57	GCLK
2	IO_L10N_2/GCLK3	P60	GCLK
2	IO_L10P_2/GCLK2	P58	GCLK
2	IO_L11N_2/DOUT	P64	DUAL
2	IO_L11P_2/AWAKE	P63	PWR MGMT
2	IO_L12N_2/D3	P68	DUAL
2	IO_L12P_2/INIT_B	P67	DUAL
2	IO_L13N_2/D0/DIN/MISO	P71	DUAL
2	IO_L13P_2/D2	P69	DUAL
2	IO_L14N_2/CCLK	P72	DUAL
2	IO_L14P_2/D1	P70	DUAL
2	IP_2/VREF_2	P53	VREF
2	VCCO_2	P40	VCCO
2	VCCO_2	P61	VCCO
3	IO_L01N_3	P6	I/O
3	IO_L01P_3	P4	I/O
3	IO_L02N_3	P5	I/O
3	IO_L02P_3	P3	I/O
3	IO_L03N_3	P8	I/O
3	IO_L03P_3	P7	I/O
3	IO_L04N_3/VREF_3	P11	VREF
3	IO_L04P_3	P10	I/O
3	IO_L05N_3/LHCLK1	P13	LHCLK
3	IO_L05P_3/LHCLK0	P12	LHCLK
3	IO_L06N_3/IRDY2/LHCLK3	P16	LHCLK
3	IO_L06P_3/LHCLK2	P15	LHCLK
3	IO_L07N_3/LHCLK5	P20	LHCLK
3	IO_L07P_3/LHCLK4	P18	LHCLK
3	IO_L08N_3/LHCLK7	P21	LHCLK
3	IO_L08P_3/TRDY2/LHCLK6	P19	LHCLK
3	IO_L09N_3	P25	I/O
3	IO_L09P_3	P24	I/O

Table 66: Spartan-3AN TQG144 Pinout (Continued)

Bank	Pin Name	Pin	Type
3	IO_L10N_3	P29	I/O
3	IO_L10P_3	P27	I/O
3	IO_L11N_3	P30	I/O
3	IO_L11P_3	P28	I/O
3	IO_L12N_3	P32	I/O
3	IO_L12P_3	P31	I/O
3	IP_L13N_3/VREF_3	P35	VREF
3	IP_L13P_3	P33	INPUT
3	VCCO_3	P14	VCCO
3	VCCO_3	P23	VCCO
GND	GND	P9	GND
GND	GND	P17	GND
GND	GND	P26	GND
GND	GND	P34	GND
GND	GND	P56	GND
GND	GND	P65	GND
GND	GND	P81	GND
GND	GND	P89	GND
GND	GND	P100	GND
GND	GND	P106	GND
GND	GND	P118	GND
GND	GND	P128	GND
GND	GND	P137	GND
VCCAUX	DONE	P73	CONFIG
VCCAUX	PROG_B	P144	CONFIG
VCCAUX	TCK	P109	JTAG
VCCAUX	TDI	P2	JTAG
VCCAUX	TDO	P107	JTAG
VCCAUX	TMS	P1	JTAG
VCCAUX	VCCAUX	P36	VCCAUX
VCCAUX	VCCAUX	P66	VCCAUX
VCCAUX	VCCAUX	P108	VCCAUX
VCCAUX	VCCAUX	P133	VCCAUX
VCCINT	VCCINT	P22	VCCINT
VCCINT	VCCINT	P52	VCCINT
VCCINT	VCCINT	P94	VCCINT
VCCINT	VCCINT	P122	VCCINT

User I/Os by Bank

Table 67 indicates how the 108 available user-I/O pins are distributed between the four I/O banks on the TQG144 package. The AWAKE pin is counted as a Dual-Purpose I/O.

Table 67: User I/Os Per Bank for the XC3S50AN in the TQG144 Package

Package Edge	I/O Bank	Maximum I/O	All Possible I/O Pins by Type				
			I/O	INPUT	DUAL	VREF	CLK
Top	0	27	14	1	1	3	8
Right	1	25	11	0	4	2	8
Bottom	2	30	2	0	21	1	6
Left	3	26	15	1	0	2	8
TOTAL		108	42	2	26	8	30

Footprint Migration Differences

The XC3S50AN FPGA is the only Spartan-3AN device offered in the TQG144 package.

The XC3S50AN FPGA is pin compatible with the Spartan-3A XC3S50A FPGA in the TQ(G)144 package, although the Spartan-3A FPGA requires an external configuration source.

TQG144 Footprint

Note pin 1 indicator in top-left corner and logo orientation.

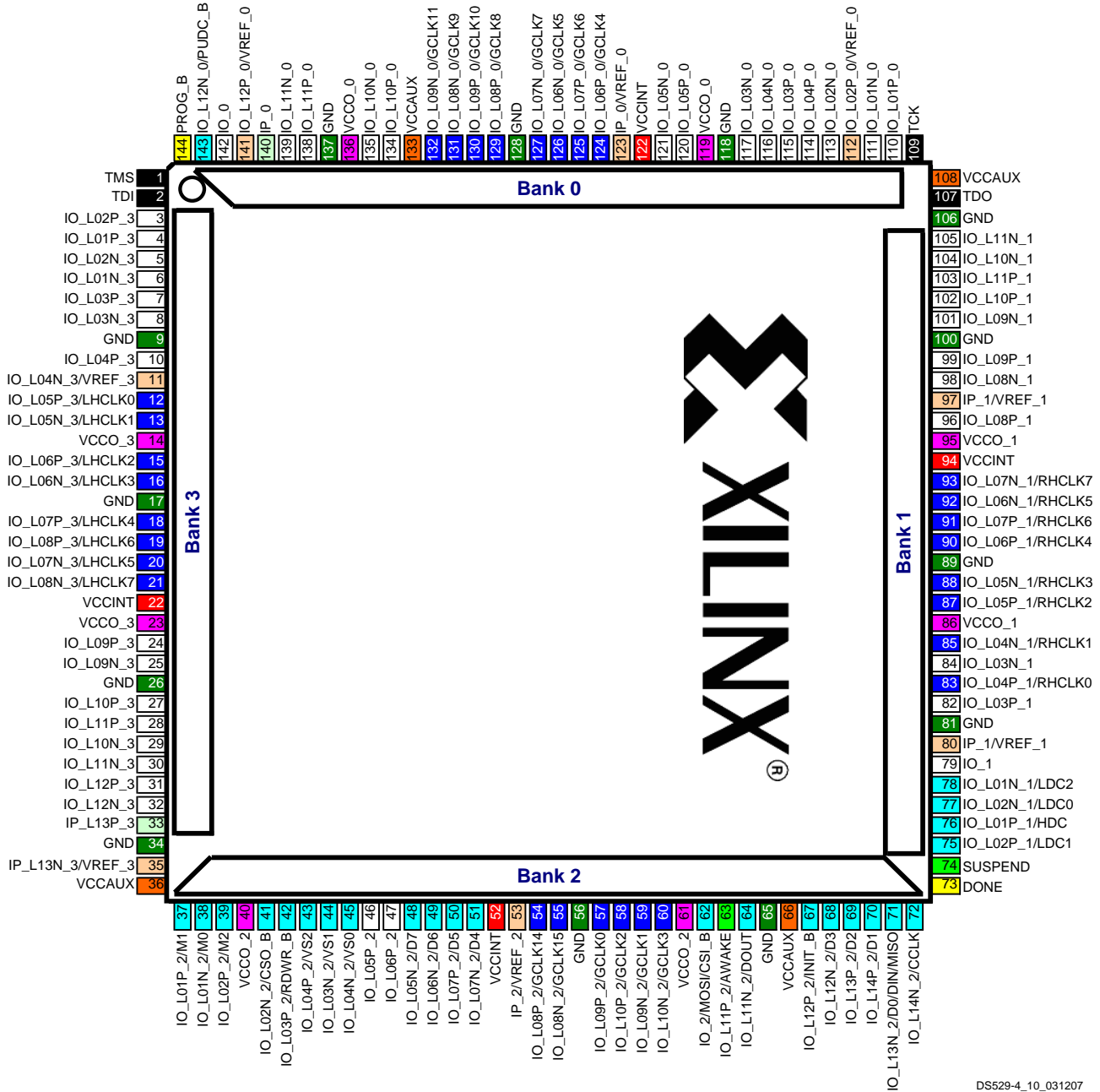


Figure 18: XC3S50AN FPGA in TQG144 Package Footprint (top view)

42	IO: Unrestricted, general-purpose user I/O	26	DUAL: Configuration, AWAKE pins, then possible user I/O	8	VREF: User I/O or input voltage reference for bank
2	INPUT: Unrestricted, general-purpose input pin	30	CLK: User I/O, input, or global buffer input	8	VCCO: Output voltage supply for bank
3	CONFIG: Dedicated configuration pins, SUSPEND pin	4	JTAG: Dedicated JTAG port pins	4	VCCINT: Internal core supply voltage (+1.2V)
0	N.C.: Not connected	13	GND: Ground	4	VCCAUX: Auxiliary supply voltage (+3.3V)